L Number	Hits	Search Text	DB	Time stamp
1	9633	(wafer with (clean$34 wash$3))	USPAT; US-PGPUB	2001/10/08 12:07
2	5	((wafer with (clean$34 wash$3))) and (air adj2 liquid adj2 interface)	USPAT; US-PGPUB	2001/10/08 12:07
3	142	((wafer with (clean$34 wash$3))) and (eddy adj3 current)	USPAT; US-PGPUB	2001/10/08 12:08
4	710	((wafer with (clean$34 wash$3))) and (surface adj3 tension)	USPAT; US-PGPUB	2001/10/08 12:08
5	9	(((wafer with (clean$34 wash$3))) and (eddy adj3 current)) and (surface adj3 tension)	USPAT; US-PGPUB	2001/10/08 12:05
6	11379	(wafer with (clean$34 wash$3))	EPO; JPO; DERWENT; IBM TDB	2001/10/08 12:07
7	0	((wafer with (clean$34 wash$3))) and (air adj2 liquid adj2 interface)	EPO; JPO; DERWENT; IBM TDB	2001/10/08 12:08
9	85	((wafer with (clean$34 wash$3))) and (surface adj3 tension)	EPO; JPO; DERWENT; IBM TDB	2001/10/08 12:08
10	12	((wafer with (clean$34 wash$3))) and (eddy adj3 current)	EPO; JPO; DERWENT; IBM TDB	2001/10/08 12:09